ROHS

HALOGEN

FREE GREEN

(5-2008)



Vishay Electro-Films



Thin Film Power Resistors



Product may not be to scale

The PWA series resistor chips offer a 500 mW power rating in a small size. These offer one of the best combinations of size and power available.

The PWAs are manufactured using Vishay Electro-Films (EFI) sophisticated thin film equipment and manufacturing technology. The PWAs are 100 % electrically tested and visually inspected to MIL-STD-883, method 2032, class H or class K.

FEATURES

- Wire bondable
- 500 mW power
- Chip size: 0.030" x 0.045"
- Case: 0503
- Resistance range 0.3 Ω to 1 M Ω
- Oxidized silicon substrate for good power dissipation



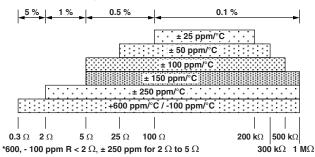
 Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>



The PWA resistor chips are used mainly in higher power circuits of amplifiers where increased power loads require a more specialized resistor.

TEMPERATURE COEFFICIENT OF RESISTANCE, VALUES, AND TOLERANCES		
PARAMETER	VALUE	UNIT
Total Resistance Range	0.3 to 1M	Ω
Standard Tolerances	± 0.1, ± 0.5, ± 1, ± 5	%
TCR	± 25, ± 50, ± 100, ± 150	ppm/°C

Tightest Standard Tolerance Available

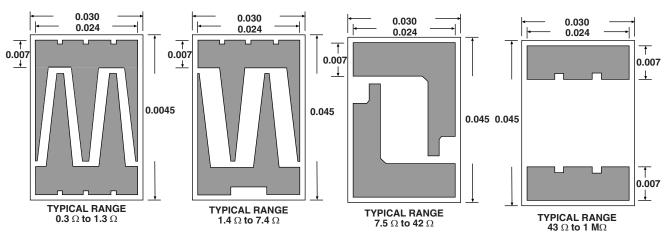


STANDARD ELECTRICAL SPECIFICATIONS		
PARAMETER	VALUE	UNIT
Noise, MIL-STD-202, Method 308 100 Ω to 250 k Ω < 100 Ω or > 251 k Ω	-35 typ. -20 typ.	dB
Moisture Resistance, MIL-STD-202, Method 106	± 0.5 max. Δ <i>R/R</i>	%
Stability, 1000 h, +125 °C, 250 mW	\pm 0.5 max. $\Delta R/R$	%
Operating Temperature Range	-55 to +125	°C
Thermal Shock, MIL-STD-202, Method 107, Test Condition F	± 0.1 max. Δ <i>R/R</i>	%
High Temperature Exposure, +150 °C, 100 h	± 0.2 max. Δ <i>R/R</i>	%
Dielectric Voltage Breakdown	200	V
Insulation Resistance	10 ¹² min.	Ω
Operating Voltage Steady State 5 x Rated Power	100 max. 200 max.	V
DC Power Rating at + 70 °C (Derated to zero at + 175 °C) (Conductive epoxy die attach to alumina substrate)	0.5	W
5 x Rated Power Short-Time Overload, + 25 °C, 5 s	± 0.1 max. ΔR/R	%



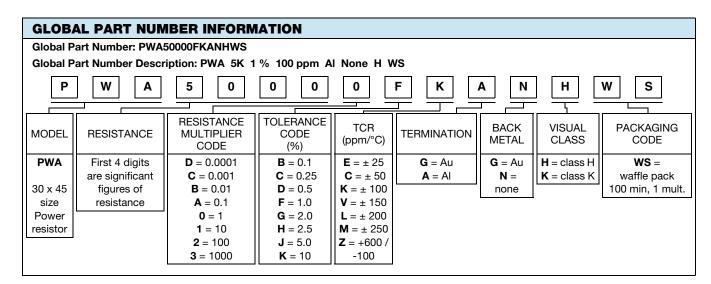
Vishay Electro-Films

DIMENSIONS in inches



SCHEMATIC

MECHANICAL SPECIFICATIONS		
PARAMETER	VALUE	
Chip Size	0.030" x 0.045" ± 0.002" (0.762 mm x 1.143 mm ± 0.5 mm)	
Chip Thickness	0.010" ± 0.002" (0.254 mm ± 0.05 mm)	
Chip Substrate Material	Oxidized silicon, 10 kÅ minimum SiO ₂	
Resistor Material	Tantalum nitride, self-passivating	
Bonding Pad Size	0.007" x 0.024" (0.1778 mm x 0.6096 mm)	
Number of Pads	2	
Pad Material	10 kÅ minimum aluminum (Au optional)	
Backing	None, lapped semiconductor silicon (Au back optional)	





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Vishay

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